

ABSTRACT OF THE DISCLOSURE

In order to fit a heat-resistant insulating film onto a circuit board mounted with electronic components, the
5 heat-resistant insulating film is three-dimensionally formed into a pattern profile corresponding to that of a surface to be insulated including concave or convex portion, and then covers the electronic components or the circuit board. This insulation of the surface to be insulated by fitting the insulating film
10 with functionality such as heat resistance enables easy insulation without waste.